4-Bit 20 Mb/s Dual-Supply Level Translator

The NLSX3378 is a 4-bit configurable dual-supply bidirectional auto sensing translator that does not require a directional control pin. The V_{CC} I/O and V_L I/O ports are designed to track two different power supply rails, V_{CC} and V_L respectively. The V_{CC} supply rail is configurable from 1.65 V to 4.5 V while V_L supply rail is configurable to 1.2 V to 4.1 V. This allows lower voltage logic signals on the V_L side to be translated into higher voltage logic signals on the V_{CC} side, and vice-versa.

The NLSX3378 translator has open—drain outputs with integrated 10 $k\Omega$ pullup resistors on the I/O lines. The integrated pullup resistors are used to pullup the I/O lines to either V_L or $V_{CC}.$ The NLSX3378 is an excellent match for open—drain applications such as the I^2C communication bus.

Features

- Wide High-Side V_{CC} Operating Range: 1.65 V to 4.5 V
 Wide Low-Side V_L Operating Range: 1.2 V to 4.1 V
- High–Speed with 20 Mb/s Guaranteed Date Rate for $V_L > 2.5 \text{ V}$
- Low Bit-to-Bit Skew
- Enable Input and I/O Lines have Overvoltage Tolerant (OVT) to 4.5 V
- Nonpreferential Powerup Sequencing
- Integrated 10 k Ω Pullup Resistors
- Small Space Saving Package 2.02 x 1.54 mm μBump12
- This is a Pb-Free Device

Typical Applications

- I²C, SMBus, PMBus
- Low Voltage ASIC Level Translation
- Mobile Phones, PDAs, Cameras

Important Information

• ESD Protection for Power, Enable and I/O Pins: Human Body Model (HBM): ±2 kV



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MARKING DIAGRAM for NLSX3378FCT1G



μBump12 FC SUFFIX CASE 499AU



for NLSX3378BFCT1G



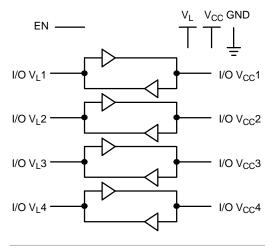
A = Assembly Location

Y = Year

WW = Work Week

= Pb-Free Package

LOGIC DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

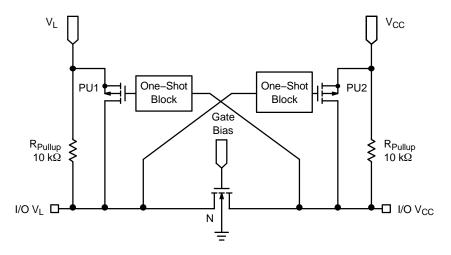


Figure 1. Block Diagram (1 I/O Line)

PIN ASSIGNMENT

| Pins | Description |
|-----------------------|---|
| V _{CC} | V _{CC} Input Voltage |
| V _L | V _L Input Voltage |
| GND | Ground |
| EN | Output Enable |
| I/O V _{CC} n | V _{CC} I/O Port, Referenced to V _{CC} |
| I/O V _L n | V _L I/O Port, Referenced to V _L |

FUNCTION TABLE

| EN | Operating Mode |
|----|---------------------|
| L | Hi–Z |
| Н | I/O Buses Connected |

PIN LOCATION

| Pin | Pin Name |
|-----|-----------------------|
| A1 | I/O V _L 1 |
| A2 | I/O V _L 2 |
| А3 | I/O V _L 3 |
| A4 | I/O VL4 |
| B1 | V _{CC} |
| B2 | V _L |
| В3 | EN |
| B4 | GND |
| C1 | I/O V _{CC} 1 |
| C2 | I/O V _{CC} 2 |
| C3 | I/O V _{CC} 3 |
| C4 | I/O V _{CC} 4 |

(Bottom View)

MAXIMUM RATINGS

| Symbol | Parameter | Value | Condition | Unit |
|---------------------|--|---------------------------------|------------|------|
| V _{CC} | High-side DC Supply Voltage | -0.3 to +7.0 | | V |
| VL | High-side DC Supply Voltage | -0.3 to +7.0 | | V |
| I/O V _{CC} | V _{CC} -Referenced DC Input/Output Voltage | -0.3 to (V _{CC} + 0.3) | | V |
| I/O V _L | V _L -Referenced DC Input/Output Voltage | -0.3 to (V _L + 0.3) | | V |
| V _{EN} | Enable Control Pin DC Input Voltage | -0.3 to +7.0 | | V |
| I _{I/O_SC} | Short-Circuit Duration (I/O V _L and I/O V _{CC} to GND) | 40 | Continuous | mA |
| T _{STG} | Storage Temperature | -65 to +150 | | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
|-----------------|--------------------------------------|------|-----|------|
| V _{CC} | High-side Positive DC Supply Voltage | 1.65 | 4.5 | V |
| VL | High-side Positive DC Supply Voltage | 1.2 | 4.1 | V |
| V _{EN} | Enable Control Pin Voltage | GND | 4.5 | V |
| V _{IO} | Enable Control Pin Voltage | GND | 4.5 | V |
| T _A | Operating Temperature Range | -40 | +85 | °C |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 1.65 \text{ V}$ to 4.5 V and $V_L = 1.2 \text{ V}$ to 4.1 V, unless otherwise specified)

| | | | - | 40°C to +85°C | C | |
|---------------------|--|--|-----------------------|---------------------|-----------------------|------|
| Symbol | Parameter | Test Conditions | Min | Typ (Notes 1, 2) | Max | Unit |
| V _{IHC} | I/O V _{CC} Input HIGH Voltage | | V _{CC} - 0.4 | _ | _ | V |
| V _{ILC} | I/O V _{CC} Input LOW Voltage | | _ | _ | 0.15 | V |
| V _{IHL} | I/O V _L Input HIGH Voltage | | V _L – 0.2 | _ | _ | V |
| V _{ILL} | I/O V _L Input LOW Voltage | | _ | _ | 0.15 | V |
| V _{IH} | Control Pin Input HIGH Voltage | | V _L – 0.2 | _ | _ | V |
| V _{IL} | Control Pin Input LOW Voltage | | _ | _ | 0.15 | V |
| V _{OHC} | I/O V _{CC} Output HIGH Voltage | I/O V _{CC} Source Current = 20 μA | 2/3 * V _{CC} | _ | _ | V |
| V _{OLC} | I/O V _{CC} Output LOW Voltage | I/O V _{CC} Sink Current = 20 μA | _ | _ | 1/3 * V _{CC} | V |
| V _{OHL} | I/O V _L Output HIGH Voltage | I/O V _L Source Current = 20 μA | 2/3 * V _L | _ | _ | V |
| V _{OLL} | I/O V _L Output LOW Voltage | I/O V _L Sink Current = 20 μA | _ | _ | 1/3 * V _L | V |
| I _{QVCC} | V _{CC} Supply Current | I/O V_{CC} and I/O V_L Unconnected, $V_{EN} = V_L$ | - | 50 | 105 | μΑ |
| I _{QVL} | V _L Supply Current | I/O V_{CC} and I/O V_L Unconnected, $V_{EN} = V_L$ | - | 0.1 | 1.0 | μΑ |
| I _{TS-VCC} | V _{CC} Tristate Output Mode Supply Current | I/O V_{CC} and I/O V_L Unconnected, V_{EN} = GND | _ | 0.1 | 2.5 | μΑ |
| I _{TS-VL} | V _L Tristate Output Mode Supply Current | I/O V_{CC} and I/O V_{L} Unconnected, V_{EN} = GND | - | 0.1 | 2.5 | μΑ |
| l _{OZ} | I/O Tristate Output Mode Leakage Current | T _A = +25°C | _ | - | 1.0 | μΑ |
| R _{PU} | Pullup Resistor I/O V _L and V _{CC} | T _A = +25°C | _ | 10 | - | kΩ |

 Typical values are for V_{CC} = +2.8 V, V_L = +1.8 V and T_A = +25°C.
 All units are production tested at T_A = +25°C. Limits over the operating temperature range are guaranteed by design.
 Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TIMING CHARACTERISTICS - RAIL-TO-RAIL DRIVING CONFIGURATIONS

(I/O test circuit of Figures 2 and 3, C_{LOAD} = 15 pF, driver output impedance \leq 50 Ω , R_{LOAD} = 1 M Ω)

| | | | -4 | 0°C to +85 (Note 3) | 5°C | |
|-------------------------|--|-----------------|-----|------------------------|-----|------|
| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
| +1.2 ≤ V _L : | ≤ V _{CC} ≤ +4.5 V | | | | | |
| t _{RVCC} | I/O V _{CC} Risetime | | | | 25 | ns |
| t _{FVCC} | I/O V _{CC} Falltime | | | | 37 | ns |
| t _{RVL} | I/O V _L Risetime | | | | 30 | ns |
| t _{FVL} | I/O V _L Falltime | | | | 30 | ns |
| t _{PDVL-VCC} | Propagation Delay (Driving I/O V _L) | | | | 30 | ns |
| t _{PDVCC-VL} | Propagation Delay (Driving I/O V _{CC}) | | | | 30 | ns |
| t _{PPSKEW} | Part-to-Part Skew | | | | 20 | nS |
| MDR | Maximum Data Rate | | 8 | | | Mb/s |
| +1.2 ≤ V _L : | ≤ V _{CC} ≤ +3.3 V | l | I | | 1 | |
| t _{RVCC} | I/O V _{CC} Risetime | | | | 25 | ns |
| t _{FVCC} | I/O V _{CC} Falltime | | | | 30 | ns |
| t _{RVL} | I/O V _L Risetime | | | | 30 | ns |
| t _{FVL} | I/O V _L Falltime | | | | 30 | ns |
| t _{PDVL-VCC} | Propagation Delay (Driving I/O V _L) | | | | 20 | ns |
| t _{PDVCC-VL} | Propagation Delay (Driving I/O V _{CC}) | | | | 20 | ns |
| t _{PPSKEW} | Part-to-Part Skew | | | | 10 | nS |
| MDR | Maximum Data Rate | | 10 | | | Mb/s |
| +1.8 ≤ V _L : | ≤ V _{CC} ≤ +2.5 V | | • | | • | |
| t _{RVCC} | I/O V _{CC} Risetime | | | | 15 | ns |
| t _{FVCC} | I/O V _{CC} Falltime | | | | 15 | ns |
| t _{RVL} | I/O V _L Risetime | | | | 15 | ns |
| t _{FVL} | I/O V _L Falltime | | | | 15 | ns |
| t _{PDVL} -VCC | Propagation Delay (Driving I/O V _L) | | | | 15 | ns |
| t _{PDVCC-VL} | Propagation Delay (Driving I/O V _{CC}) | | | | 15 | ns |
| t _{PPSKEW} | Part-to-Part Skew | | | | 10 | nS |
| MDR | Maximum Data Rate | | 16 | | | Mb/s |
| +2.5 ≤ V _L : | ≤ V _{CC} ≤ +3.3 V | | • | | • | - |
| t _{RVCC} | I/O V _{CC} Risetime | | | | 15 | ns |
| t _{FVCC} | I/O V _{CC} Falltime | | | | 15 | ns |
| t _{RVL} | I/O V _L Risetime | | | | 15 | ns |
| t _{FVL} | I/O V _L Falltime | | | | 15 | ns |
| t _{PDVL-VCC} | Propagation Delay (Driving I/O V _L) | | | | 15 | ns |
| t _{PDVCC-VL} | Propagation Delay (Driving I/O V _{CC}) | | | | 15 | ns |
| t _{PPSKEW} | Part-to-Part Skew | | | | 10 | nS |
| MDR | Maximum Data Rate | | 20 | | | Mb/s |

^{3.} All units are production tested at $T_A = +25$ °C. Limits over the operating temperature range are guaranteed by design.

TIMING CHARACTERISTICS - OPEN DRAIN DRIVING CONFIGURATIONS

(I/O test circuit of Figures 4 and 5, C_{LOAD} = 15 pF, driver output impedance \leq 50 Ω , R_{LOAD} = 1 M Ω)

| | | | -4 | 0°C to +85 (Note 4) | °C | |
|-------------------------|--|-----------------|-----|------------------------|------|------|
| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
| +1.2 ≤ V _L ≤ | ≤ V _{CC} ≤ +4.5 V | | | | | |
| t _{RVCC} | I/O V _{CC} Risetime | | | | 400 | ns |
| t _{FVCC} | I/O V _{CC} Falltime | | | | 50 | ns |
| t _{RVL} | I/O V _L Risetime | | | | 400 | ns |
| t _{FVL} | I/O V _L Falltime | | | | 60 | ns |
| t _{PDVL} -VCC | Propagation Delay (Driving I/O V _L) | | | | 1000 | ns |
| t _{PDVCC-VL} | Propagation Delay (Driving I/O V _{CC}) | | | | 1000 | ns |
| t _{PPSKEW} | Part-to-Part Skew | | | | 50 | nS |
| MDR | Maximum Data Rate | | 2 | | | Mb/s |

^{4.} All units are production tested at T_A = +25°C. Limits over the operating temperature range are guaranteed by design. Limits over the operating temperature range are guaranteed by design.

TEST SETUPS

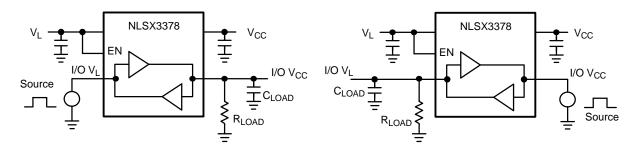


Figure 2. Rail-to-Rail Driving I/O V_L

Figure 3. Rail-to-Rail Driving I/O V_{CC}

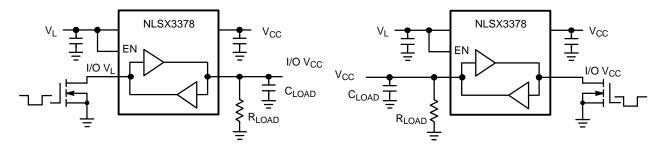


Figure 4. Open-Drain Driving I/O V_L

Figure 5. Open-Drain Driving I/O V_{CC}

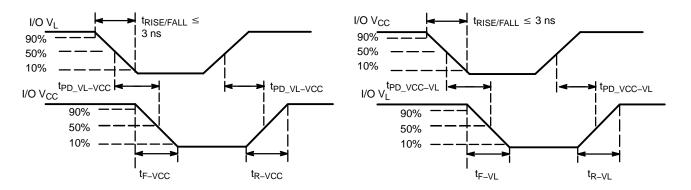
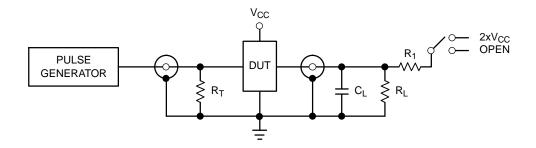


Figure 6. Definition of Timing Specification Parameters



| Test | Switch |
|-------------------------------------|---------------------|
| t _{PZH} , t _{PHZ} | Open |
| t _{PZL} , t _{PLZ} | 2 x V _{CC} |

 C_L = 15 pF or equivalent (Includes jig and probe capacitance) R_L = R_1 = 50 kΩ or equivalent R_T = Z_{OUT} of pulse generator (typically 50 Ω)

Figure 7. Test Circuit for Enable/Disable Time Measurement

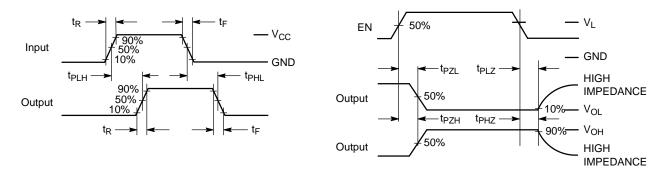


Figure 8. Timing Definitions for Propagation Delays and Enable/Disable Measurement

APPLICATIONS INFORMATION

Level Translator Architecture

The NLSX3378 auto sense translator provides bi–directional voltage level shifting to transfer data in multiple supply voltage systems. This device has two supply voltages, V_L and V_{CC} , which set the logic levels on the input and output sides of the translator. When used to transfer data from the V_L to the V_{CC} ports, input signals referenced to the V_L supply are translated to output signals with a logic level matched to V_{CC} . In a similar manner, the V_{CC} to V_L translation shifts input signals with a logic level compatible to V_{CC} to an output signal matched to V_L .

The NLSX3378 consists of two bi-directional channels that independently determine the direction of the data flow without requiring a directional pin. The one-shot circuits are used to detect the rising or falling input signals. In addition, the one shots decrease the rise and fall time of the output signal for high-to-low and low-to-high transitions.

Each input/output channel has an internal 10 k Ω pull. The magnitude of the pullup resistors can be reduced by connecting external resistors in parallel to the internal 10 k Ω resistors.

Input Driver Requirements

The rise (t_R) and fall (t_F) timing parameters of the open drain outputs depend on the magnitude of the pull–up resistors. In addition, the propagation times (t_{PD}), skew (t_{PSKEW}) and maximum data rate depend on the impedance of the device that is connected to the translator. The timing parameters listed in the data sheet assume that the output impedance of the drivers connected to the translator is less than 50 k Ω .

Enable Input (EN)

The NLSX3378 has an Enable pin (EN) that provides tri–state operation at the I/O pins. Driving the Enable pin to a low logic level minimizes the power consumption of the device and drives the I/O $V_{\rm CC}$ and I/O $V_{\rm L}$ pins to a high impedance state. Normal translation operation occurs when the EN pin is equal to a logic high signal. The EN pin is referenced to the $V_{\rm L}$ supply and has Overvoltage Tolerant (OVT) protection.

Power Supply Guidelines

During normal operation, supply voltage V_L should be less than or equal to V_{CC} . The sequencing of the power supplies will not damage the device during the power up operation.

The enable pin should be used to enter the low current tri–state mode, rather than setting either the V_L or V_{CC} supplies to 0 V. The NLSX3378 will not be damaged if either V_L or V_{CC} is equal to 0 V while the other supply voltage is at a nominal operating value; however, the operation of the translator cannot be guaranteed during single supply operation.

For optimal performance, 0.01 μF to 0.1 μF decoupling capacitors should be used on the V_L and V_{CC} power supply pins. Ceramic capacitors are a good design choice to filter and bypass any noise signals on the voltage lines to the ground plane of the PCB. The noise immunity will be maximized by placing the capacitors as close as possible to the supply and ground pins, along with minimizing the PCB connection traces.

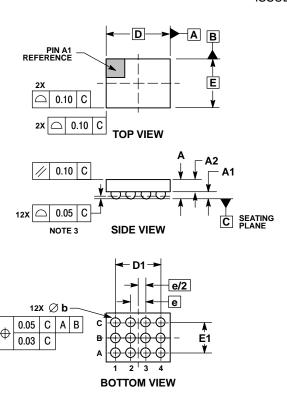
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|---|-----------------------|
| NLSX3378FCT1G | μBump12 (Pb-Free) | 3000 / Tape & Reel |
| NLSX3378BFCT1G | μBump12 (Backside Laminate Coating) (Pb–Free) | 3000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

μBump12, 2.02x1.54, 0.5P CASE 499AU-01 **ISSUE O**



- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

| | MILLIMETERS | | |
|-----|-------------|------|--|
| DIM | MIN | MAX | |
| Α | | 0.66 | |
| A1 | 0.21 | 0.27 | |
| A2 | 0.33 | 0.39 | |
| b | 0.29 | 0.34 | |
| D | 2.02 | BSC | |
| D1 | 1.50 | BSC | |
| Е | 1.54 BSC | | |
| E1 | 1.00 | BSC | |
| е | 0.50 | BSC | |

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